### Computer Organization 1

### Types of Computers

- 1. Personal Computers (PCs)
  - Intended for a single user at a stationary location
  - Notebooks and workstations
  - Emphasize good performance to single users at low cost

#### 2. Servers

- Accessed by other computers to provide computation and/or data
- Typically only accessed via a network
- Greater computing, storage, and I/O capacity
- Emphasis on performing well under large workloads with enhanced dependability
- 3. Embedded Computers
  - Most Prevalent type of computer/computer class
  - Computers contained in other devices
  - Usually a small number of predetermined applications
  - Emphasis on cost and low power
- 4. Personal Mobile Device
  - Battery-powered wireless devices with multimedia user interfaces
  - Smart phones and tablets
  - Reliance on touch screens
  - Emphasis on cost and energy efficiency
- 5. Large Cluster/Warehouse-Scale-Computers (WSCs)
  - Large collections of servers connected by a network to act as a single powerful computer
  - Scalability and availability handled through the network

## Eight Great Architecture Ideas

- 1. Design for Moore's Law
- 2. Abstraction
- 3. Make the common case fast
- 4. Parallelism
- 5. Pipelining
- 6. Prediction
- 7. Hierarhy
- 8. Improve dependability via redundancy

#### Steps for executing a program

1. Input device loads the machine code from the executable

- 2. The machine code is stored in memory
- 3. Processor fetches an instruction
- 4. Control decodes the instruction
- 5. Datapath executes the instruction
- 6. If application does not complete, then go to step 3

**REMEMBER:** When executing a program, you first decode the instructions for the control, and then execute the instructions.

**REMEMBER:** QTSpim is **not** a compiler, it is an **assembler**.

Formulas to remember:

$$\begin{aligned} \text{Dies per Wafer} &\approx \frac{\text{Wafer Area}}{\text{Die Area}} \\ \text{Yield} &= \frac{1}{(1 + (\text{Defects per area})(\frac{\text{Die Area}}{2}))^2} \\ \text{Cost per Die} &= \frac{\text{Wafer Cost}}{(\text{Die per Wafer}) * \text{yield}} \end{aligned}$$

When comparing performance between  $Computer_x$  and  $Computer_y$ :

$$\begin{aligned} \text{Performance} &= \frac{1}{\text{Execution Time}} \\ \text{Performance}_x &> \text{Performance}_y \\ \frac{1}{\text{Execution Time}_x} &> \frac{1}{\text{Execution Time}_y} \\ \text{Execution Time}_y &> \text{Execution Time}_x \end{aligned}$$

Finding CPU Time:

CPU Time = CPU Clock Cycles \* CPU Clock Cycle Time = 
$$\frac{\text{CPU Clock Cycles}}{\text{CPU clock rate}}$$
 
$$\text{CPI} = \frac{\text{CPU Clock Cycles}}{\text{Instruction Count}}$$
 
$$\text{CPU Time} = \text{Instruction Count} * \text{CPI} * \text{CPU Clock Cycles}$$

Relationship between clock rate and clock speed rotation:

$$\operatorname{clock\ rate} = \frac{1}{\operatorname{clock\ speed}}$$
 
$$\operatorname{clock\ speed} = \frac{1}{\operatorname{clock\ rate}}$$

# Calculate Overall Speedup

execution time<sub>new</sub> = execution time<sub>old</sub> \* 
$$(1 - \text{fraction}_{enhanced} + \frac{\text{fraction}_{enhanced}}{\text{speedup}_{enhanced}})$$

$$\text{speedup}_{overall} = \frac{\text{execution time}_{old}}{\text{execution time}_{new}} = \frac{1}{(1 - \text{fraction}_{enhanced}) + \frac{\text{fraction}_{enhanced}}{\text{speedup}_{enhanced}}}$$

Terms to know:

- 1. Latency Response (execution time): The time between the start and completion of an event or task.
- 2. Bandwidth/Throughput: The total amount of work done in a given period of time.
- 3. Clock cycles Per Instruction (CPI): Average number of clock cycles per instruction for a program or process
- 4. **Amdahl's Law**: The performance improvement gained from using an enhanced component is limited by the portion improved.

**REMEMBER:** The memory access bottleneck is caused by fast execution time and slower memory access time. To solve this we use **3 layers of cache** 

Conversions:

1 Kib (Kibibyte) =  $2^{10}$  bytes or 1024 bytes

1 Kib = 1024 bytes = 1.024 KB

For memory:  $2^n$  can store  $\{0, 1, ..., 2^{n-1}\}$  bytes.

Power Issues:

**Energy** is the capacity to change an object's state. Measured in joules.

One joule is equal to one Newton acting through one meter.

Power is the energy amount used over a period of time, units are Watts.

Watts = 
$$\frac{joules}{second}$$

$$Power = \frac{\Delta Energy}{\Delta Time}$$

- 1. There is a need for energy efficient Processors because of the major issue of heat.
- 2. Complementary Metal Oxide Semiconductors (CMOSs):
  - (a) dominant technology for integrated circuits, energy consumption consists of dynamic and static energy.
  - (b) **Dynamic Energy:** The energy consumed by the switching of transistors from 0 to 1 or 1 to 0, this is dependent on the capacitive loading of each transistor and the voltage applied. The **Dynamic Power** is the power required per transistor
    - i. Energy  $\propto \frac{1}{2} * \text{Capacitive load} * \text{Voltage}^2$
    - ii. Power  $\propto \frac{1}{2}$  \* Capacitive load \* Voltage<sup>2</sup> \* Frequency switched
    - iii. ∴ Power ∝ Energy \* Frequency Switched
  - (c) **Static Energy:** energy consumed through current leakage, this is the current that flows through a transistor even when it is off (approximately 40% of power consumption.)
  - (d) Static power: power lost from static energy, is proportional to the number of

Techniques to Improve Energy Efficiency

- 1. Turn off the clock for inactive modules (do nothing efficiently)
- 2. Use a lower clock frequency during periods of low activity (called dynamic frequency scaling or DFS), can often allow lower voltages as well
- 3. Use a low power mode for memory and storage when not being accessed
- 4. Completely turn off power to subsets of the chip when not being used

Number Notation The value of a specific numer in a specified base (radix) is calculated by:

$$\sum_{i=-m}^{n-1} d_i * b^i = d_{n-1} * 10^{n-1} + \dots + d_1 * 10^1 + \dots + d_{-m} * 10^{-m}$$

where d is a digit and b is the base.

#### **EXAMPLE**

$$425.34_{10} = \sum_{i=-2}^{3} d_i * 10^i = (4*10^2) + (2*10^1) + (5*10^0) + (3*10^{-1}) + (4*10^{-2}) = 400 + 20 + 5 + 0.3 + 0.04$$

$$1001.01_2 = \sum_{i=-2}^4 \mathbf{d}_i * 2^i = (1*2^3) + (0*2^2) + (0*2^1) + (1*2^0) + (0*2^{-1}) + (1*2^{-2}) = 8 + 0 + 0 + 1 + 0 + 0.25 = 9.25$$

Range of values: To find the range of numbers that can be represented by a certain base with n digits, use the formula  $M^N$  where M =base and N =number of digits.

So a base 10 number with 3 decimal number values can represent  $M^N = 10^3 = 1000$  numbers, the range would be [0, 999]. If it was base 2, then  $M^N = 2^3 = 8$  or [0, 7]